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KB354NT

Features

1.AC inputs.

- 2.High current transfer ratio.
- 2.Opaque type, mini-flat package.

3.Subminiature type (The volume is smaller than that of our conventional DIP

type by as far as 30%).

4. Isolation voltage between input and output Viso:3750Vrms.

5. Employs double transfer mold technology.

6.Recognized by UL and CUL, file NO.E225308.

7.Packge : 1000Pcs / Reel.

8.RoHS Compliant.

Applications

1. Hybrid substrates that require high density mounting.

2.Programmable controllers.

*PACKAGE DIMENSIONS (UNIT:mm) SMD Type

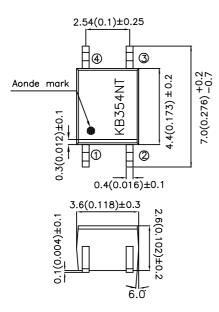
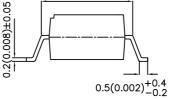


diagram (1) Anode/Cathode (2) Cathode/Anode (3) Emitter (4) (3) (1) Anode/Cathode (4) Collector (5.3(0.209)±0.3) (5) (200)±0.3

Internal connection



 $\label{eq:unit:mm} \begin{array}{l} \text{UNIT: MM[INCH]} \\ \text{TOLERANCE: } \pm 0.5 [\pm 0.02] \\ \end{array} \\ \begin{array}{l} \text{UNLESS OTHERWISE NOTED.} \end{array}$

PAGE: 1 OF 7 ERP:1205000038

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*Absolute Maximum Ratings (Ta=25°C)

| | Parameter | Symbol | Rating | Unit | |
|--------------------------|-----------------------------|--------|-------------|------|--|
| | Forward current | lF | ±50 | mA | |
| Input | Power dissipation | Р | 70 | mW | |
| Output | Collector-emitter voltage | Vceo | 35 | V | |
| | Emitter-collector voltage | Veco | 6 | V | |
| | Collector current | IC | 50 | mA | |
| | Collector power dissipation | Pc | 150 | mW | |
| Total powe | er dissipation | P tot | 170 | mW | |
| ^{*1} Isolation | voltage | V iso | 3750 | Vrms | |
| Operating temperature | | T opr | -30 to +100 | °C | |
| Storage temperature | | T stg | -55 to +125 | °C | |
| *2 Soldering temperature | | T sol | 260 | °C | |

*1 40 to 60% RH, AC for1 minute.

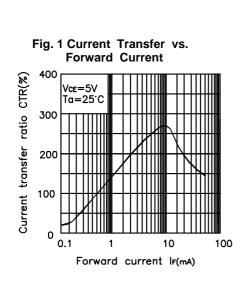
*2 For 10 seconds.

***Electro-optical Characteristics**

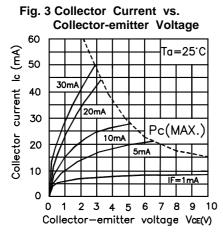
| Parameter | | Symbol | Conditions | Min. | Тур. | Max. | Unit | |
|----------------------------------|--------------------------------------|-----------|-------------------|----------------------------|------|------|------------------|----|
| Input | Forward voltage | | VF | IF=± 20mA | - | 1.2 | 1.4 | V |
| | Peak forward voltage | | Vfm | IFM=0.5A | - | - | 3.0 | V |
| Output | Collector dark current | | ICEO | Vce=20V IF=0 | - | - | 10 ⁻⁷ | А |
| | Collector-emitter breakdown voltage | | BV _{CEO} | I _C =0.1mA IF=0 | 35 | - | - | V |
| | Emitter-collector breakdown voltage | | BV _{ECO} | I _E =10uA IF=0 | 6 | - | | V |
| Transfer charact- eristics | Current transfer ration | | CTR | IF=± 1mA Vce=5V | 20 | - | 400 | % |
| | Collector-emitter saturation voltage | | VCE (sat) | IF=± 20mA IC=1mA | - | 0.1 | 0.2 | V |
| | Response time Fall time | Rise time | tr | Vce=2V IC=2mA RL=100Ω | - | 4 | 18 | uS |
| | | Fall time | tr | | | 3 | 18 | uS |

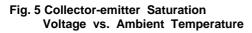
| Model No. | Rank mark | CTR(%) |
|-----------|--------------|-----------|
| KB354N1T | A | 50 to 150 |
| KB354NT | A or No mark | 20 to 400 |

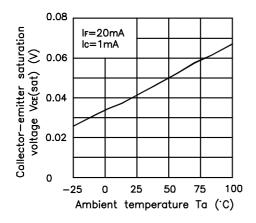
PHOTOCOUPLER



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SPEC NO: DSAD2837 APPROVED: J. Lu

PAGE: 3 OF 7 ERP:1205000038



Fig. 2 Forward Current vs.

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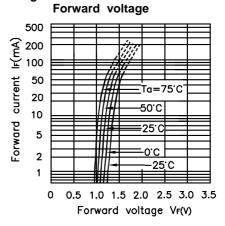
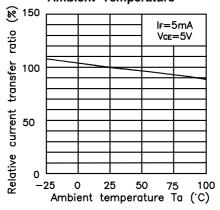


Fig. 4 Forward Current vs. Ambient Temperature



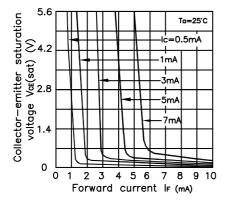
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Fig. 6 Response Time vs.

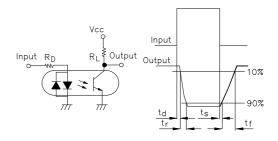
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Load Resistance 500 Vce=2V 200 lc=2mA Ta=25°C Response time (μ s) 100 50 20 10 5 td 2 тп 1 0.5 0.2 0.1 0.01 50 0.1 1 10 Load resistance $RL(K\Omega)$

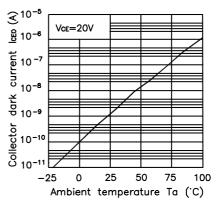
Fig. 7 Collector-emitter Saturation Voltage vs. Forward Current



Test Circuit for Response Time









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* NOTES ON HANDLING

1.Recommended soldering conditions (Dip soldering)

(1) Dip soldering

| Temperature | 260°C or below (molten solder temperature) |
|-------------|--|
| Time | Less than 10 seconds. |
| Cycle | One cycle allowed to be dipped in solder including plastic nold portion. |
| Flux | Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt % is recommended.) |

(2) Cautions

Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

2.Cautions regarding noise

Be aware that power is suddenly into the component any surge current may cause damage happen,

even if the voltage is within the absolute maximum ratings.

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NOTES ON HANDLING

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1.Recommended soldering conditions

- (1).Infrared reflow soldering
 - · Peak reflow temperature

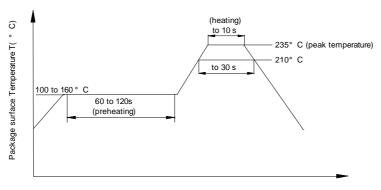
235 ° C or below(package surface temperature)

- Time of temperature higher than 210 ° C 30 seconds or less
- Number or reflows
- Flux

Rosin flux containing small amount of chlorine(The flux with a

maximum chlorine content of 0.2Wt % is recommended.)

Recommended Temperature Profile of infrared Reflow



CAUTION

Within this device there exists GaAs (Gallium Arsenide) material which is a harmful substance if ingested. GaAs dust and fumes are toxic. Do not break, cut or pulverize the product, or use chemicals to dissolve them.

RESTRICTIONS ON PRODUCT USE

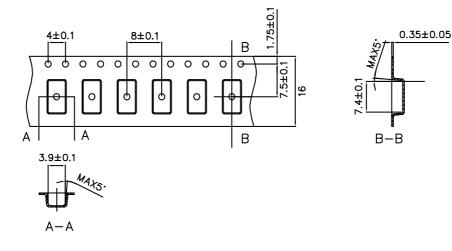
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PAGE: 6 OF 7 ERP:1205000038

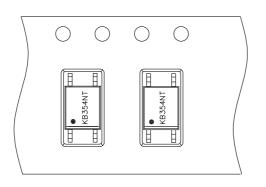
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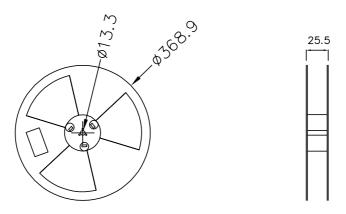
Outline and Dimension(Tape) (Units : mm)



Tape Direction



Outline and Dimension(Reel)



Packing:1000pcs/reel